

## Leaded Solid Solder Wire for High Reliability Soldering

## Product Description

For soldering applications that require maximum reliability of solder joints, especially for surface mounted components, through hole and final assembly, only solder of the highest purity is acceptable. Kester does not make any vague claims of understanding solder purity. Only the highest quality metals are used to make Kester Solder Wire. Complete analysis of Kester Solder Wire prove that every batch conforms to the strictest quality controls in the solder industry.

#### **Maximum Allowed Impurities**

Kester Solder Wire meets IPC Specifications J-STD-006C Amendment 1.

Element	Symbol	ANSI/IPC J-STD-006C
Antimony	Sb	0.200
Copper	Cu	0.080
Gold	Au	0.050
Aluminum	AI	0.005
Cadmium	Cd	0.002
Zinc	Zn	0.003
Silver	Ag	0.100
Bismuth	Bi	0.100
Arsenic	As	0.030
Iron	Fe	0.020
Nickel	Ni	0.010
Indium	In	0.100

The component elements in each alloy shall deviate from their nominal mass percentage by not more than 0.020% of the alloy mass when their nominal percentage is <0.10%; by not more than 0.10% of the alloy mass when their nominal percentage is >0.10% to <1.0%; by not more than 0.20% of the alloy mass when their nominal percentage is >1.0% to <5.0% or by not more than 0.50% when their nominal percentage is >5.0%.

Kester solder purchased directly or through stocking distributors will conform to these requirements. Only highest purity virgin metals are used to make Kester wire. DOD-STD-2000-1A (Soldering Technology High Quality/High Reliability) states that it is the responsibility of the manufacturer to select those materials and processes that will produce acceptable high quality/high reliability products.

## RoHS Compliance

Kester does not determine any applicable Restriction of Hazardous Substances (RoHS) exemptions for our lead containing products at the user level.

# **Application Notes**



### Availability

Alloy	Melting Point
Sn63Pb37	183° (361°F)
Sn60Pb40	183-190°C (361-374°F)
Sn50Pb50	183-212°C (361-414°F)
Sn40Pb60	183-238°C (361-460°F)
Sn5Pb93.5Ag1.5	296-301°C (565-574°F)
Sn5Pb95	301-314°C (574-597°F)

Other alloy compositions may be available. Consult your local Kester Sales Representative.

### Storage and Warranty Period

Storage must be in a dry, non-corrosive environment between 10-40°C (50-104°F). The surface may lose its shine and appear a dull shade of grey. This is a surface phenomenon and is not detrimental to product functionality. Solid solder wire has a limited warranty period determined by the alloy used in the wire. For alloys containing more than 70% lead, the warranty period is 2 years from the date of manufacture. Other alloys have a warranty period of 3 years from the date of manufacture.

### Health and Safety

This product, during handling or use, may be hazardous to your health or the environment. Read the Safety Data Sheet (SDS) and warning label before using this product.